



Click [here](#) for the 3D model.

Dimensions

| | |
|-----------|-----------------|
| Chip Size | 1250(5350) |
| AEC-Q200 | Yes |
| L | 13.2mm +/-0.4mm |
| W | 12.5mm +/-0.2mm |
| T | 5mm MAX |
| G | 4.7mm +/-0.3mm |

Packaging Specifications

| | |
|--------------------------|------------|
| Typical Component Weight | 4.2 g |
| Packaging | T&R, 330mm |
| Packaging Quantity | 250 |

General Information

| | |
|----------------|------------------------------|
| Series | MPXV |
| Style | SMD Molded |
| Core | Metal Composite |
| Description | Surface Mount Inductor |
| Features | Power Inductors |
| RoHS | Yes |
| Qualifications | AEC-Q200 |
| AEC-Q200 | Yes |
| Miscellaneous | 40 (K) Temperature Rise Max. |

Specifications

| | |
|-------------------------|------------------------------------------------------------------------------------------------------------------|
| Inductance | 22 uH |
| Inductance Tolerance | 20% |
| Temperature Range | -55/+155°C |
| Shielded | Yes |
| Current | 6.7 A (Irms, 40C Rise By Self Heating), 6.5 A (Isat, 20% Drop In Inductance), 9 A (Isat, 30% Drop In Inductance) |
| DC Resistance | 46.2 mOhms |
| Self-Resonant Frequency | 6.5 MHz |